



Cryostat Design

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CERN Accelerator School «Superconductivity for Accelerators»

Ettore Majorana Foundation and Centre for Scientific Culture Erice, Italy, 24 April – 4 May 2013



hour

Content



Introduction to cryostatsCryostat requirements

• Heat transfer for cryostats:

- Solid conduction
- Residual gas conduction
- Radiation, MLI protection, thermal shielding
- Cryogenics
- Heat intercepts

• Insulation vacuum and construction issues

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- Mechanical considerations and construction codes
- Supporting systems
- Over-pressure safety issues

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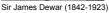


A bit of History



- Cryostat (from cryo meaning cold and stat meaning stable): "a device used to maintain at cryogenic temperatures samples or devices mounted within the cryostat"
- Dewar invents the "dewar", 1892, London
- · A dewar: the first performing cryostat
 - silvered, double-walled, glass vacuum vessel to contain cryogenic liquids
 - J.Dewar: 1st liquefaction of H₂ in 1897
 - ...but did not manage liquefaction of He, achieved by H.Kamerlingh Onnes in 1908
- Glassblowers: the "enabling technology" of the epoque:
 - J.Dewar did not patent his invention...
 - H.K.Onnes created the "Leidse Instrumentmakersschool" (still existing!), and industrialized cryostats





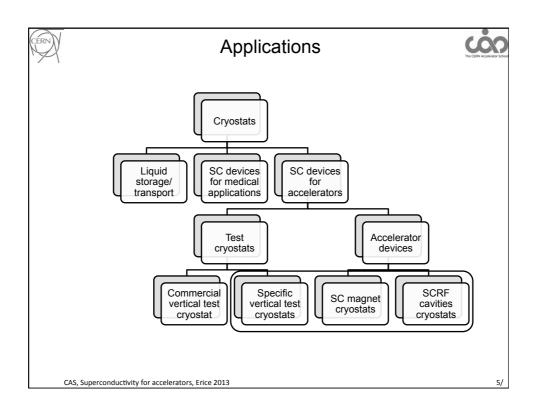


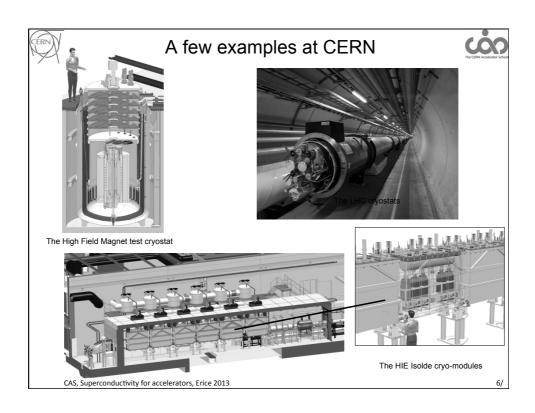
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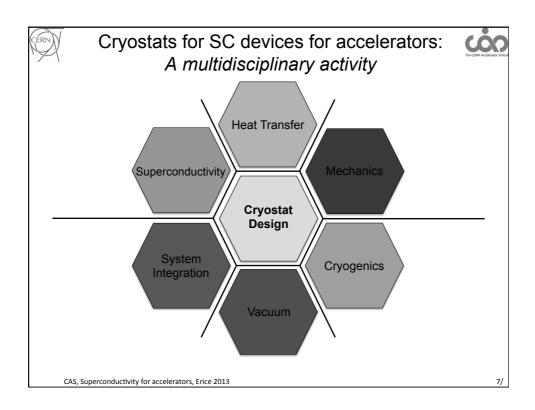
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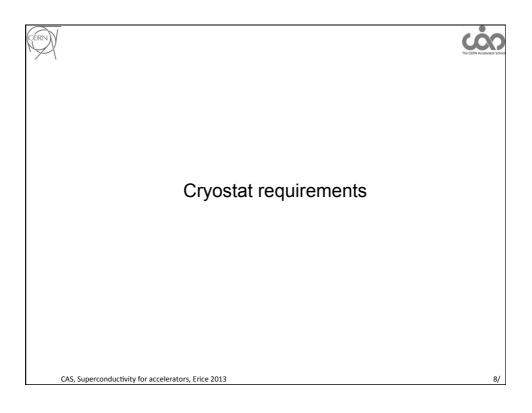
Dewars on "Google images"

| Deward | Deward | Decomposition |











Functions



Two main functions:

- · Mechanical housing of cryogenic devices (supporting systems):
 - Supporting of (sometimes heavy) devices
 - Accurate & reproducible positioning (almost always)
 - Precise alignment capabilities (SC devices in accelerators)
- Thermal efficiency of the cryostat (heat loads as low as possible):
 - Cooling capability (SC device, thermal shields and heat intercepts)
 - Insulation vacuum (SC devices "hidden" in vessels)
 - Thermal radiation shielding (screens, MLI)
 - Low heat conduction (low thermal conductivity materials)

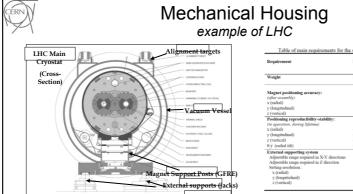
Often conflicting, > calls for trade off design solutions

Many other complementary functions...:

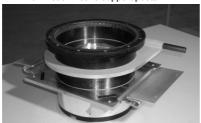
- Integration of cryogenic equipment (ph.separators, valves, etc.)
- Cryogenic cooling piping and interfaces to cryoplant
- Integration of Beam instrumentation (e.g.BPMs, BLMs,etc.)
- Instrumentation wires feed-throughs (control/diagnostics)
- magnetic shielding from/to environment (e.g. SCRF cavites, magnets)
- Maintainability (access ports)
- Handling and transport features
- ..

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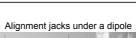
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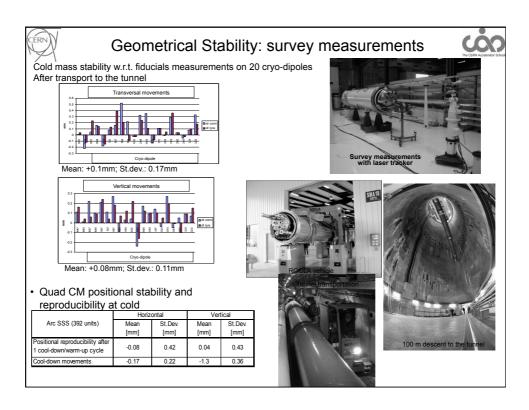


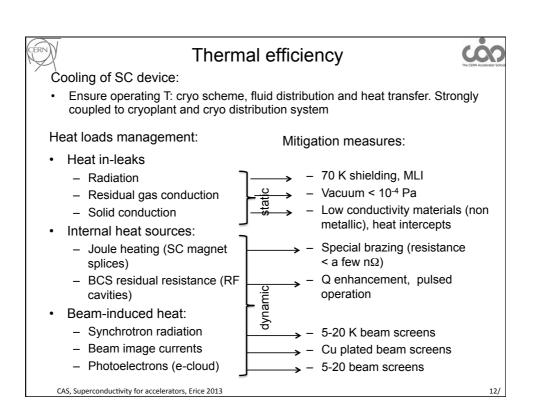


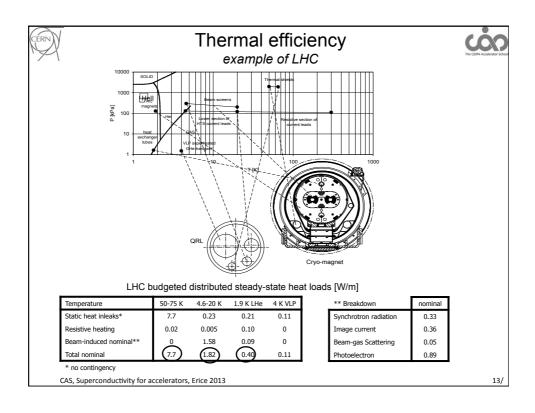
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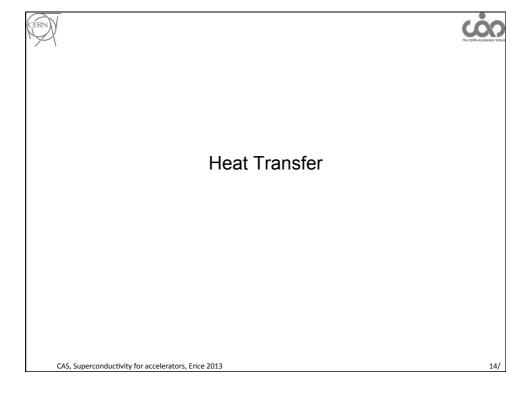














Heat transfer: General



Solid conduction:

$$Q_c = \frac{S}{L} \cdot \int_{T_c}^{T_W} \lambda(T) dT$$



· Thermal radiation: (with and without MLI)

$$Q_r = \sigma \cdot E \cdot S_i \cdot \left(T_w^4 - T_c^4 \right)$$
Between cylinders: $E = \frac{\varepsilon_i \cdot \varepsilon_c}{\sigma_i}$



Viscous gas conduction and natural convection: (Negligible with good insulation vacuum, < 10⁴ Pa)



Gas conduction: molecular regime $Q_{\rm res} = A_1 \cdot \alpha(T) \cdot \Omega \cdot P \cdot (T_2 - T_1)$

$$Q_{res} = A_1 \cdot \alpha(T) \cdot \Omega \cdot P \cdot (T_2 - T_1)$$



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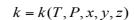
Thermal conduction



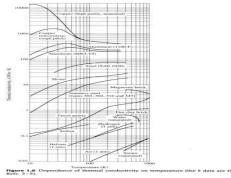
Thermal Conduction



- When a T gradient exists in a body, there is a heat transfer from the high T region to the low T region (Fourier Law):
- Q $Q = -kA \operatorname{grad}(T)$
- For one-dimensional problems (ex. a bar or tube):
- $\dot{Q} = -kA \frac{dT}{dx}$
- k is the thermal conductivity (W/mK⁻¹), normally a function of P,T, material structure, nonhomogeneity, anisotropy (ex. Composite materials).



- k is strongly T-dependent and nonlinear at low T
- "good conductors" vs. "poor conductors" → k range ~ 5 orders of magnitude



Note: sometimes conductivity denoted by λ .

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Thermal conductivity in solids (& metals)



- The conductivity is attributed to the movement of conduction electrons ("electron gas"), k_e , and the effects of phonon lattice vibrations, k_1 . $k = k_e + k_l$

The movement of conduction electrons is impeded by scatter: interactions with phonons, and interactions with impurities/imperfections. We can introduce thermal resistivities:

$$\frac{1}{k_{e}} = \frac{1}{k_{p}} + \frac{1}{k_{i}} \qquad \frac{1}{k_{p}} = a_{p}T^{2}$$

$$\frac{1}{k_{p}} = \frac{1}{k_{p}} + \frac{1}{k_{i}} \qquad \frac{1}{k_{p}} = \frac{1}{k_{p}}$$

and a_p, a_i constants

Therefore for metals, the resistivity can be expressed as:

$$k = \frac{1}{a_p T^2 + \frac{a_i}{T}}$$

And has a maximum conductivity:

trivity:

$$k_{\text{max}} = \frac{3}{2^{\frac{2}{3}}} a_p^{\frac{1}{3}} a_i^{\frac{2}{3}} \text{ at } T = \left(\frac{a_i}{2a_p}\right)^{\frac{1}{3}}$$

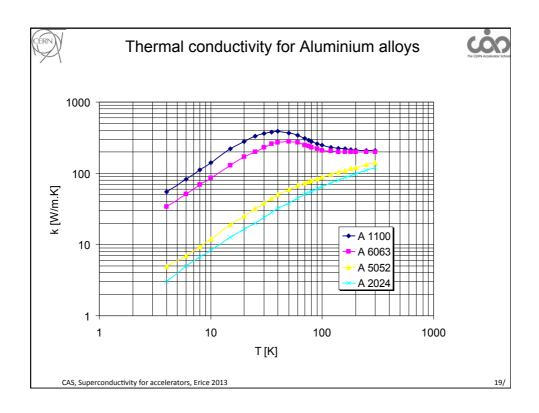
Therefore, for metals:

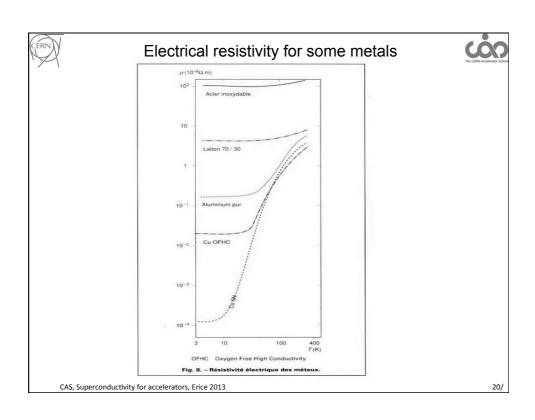
- Kmax shifts at higher T with increasing impurity (see coppers and aluminiums)
 The maximum vanishes for highly impure alloys (see steels) and in these cases impurity scattering dominates phonon scattering, thus at T < RT: \ensuremath{T}

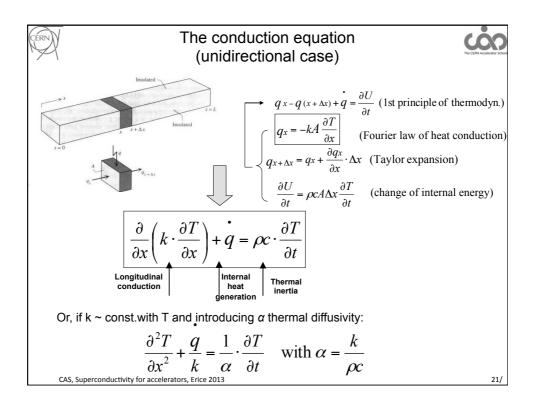
$$k \cong \frac{T}{}$$

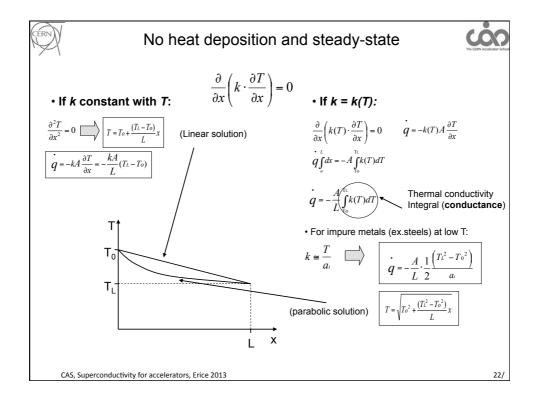
- For **metals**, from electron conduction theory and analogy with electrical diffusion \rightarrow **Wiedemann-Franz law**:
 - Good agreement at T<< and T>> RT
 - Better agreement from T<< to T>> with increasing impurities Electrical resistivity easier to measure than thermal conductivity

$$k = \frac{Lo}{\rho e}T$$
 $Lo = 2.45 \cdot 10^{-8} \left(\frac{V}{K}\right)^2$ (Constant for metals)













Electrical network analogy

- The inverse of the thermal conductance → thermal resistance:
- a) For constant k:

$$R = \frac{L}{kA}$$

$$R = \frac{L}{kA} \qquad \dot{q} = -\frac{kA}{L} (T_L - T_o) = \frac{T_0 - T_L}{R}$$

b) For variable k, define an average value k_{AV} :

$$k_{AV} = \int_{-T_0}^{TL} k(T) dT$$

$$R_t = \frac{L}{k_{total}}$$

$$k_{AV} = \frac{\int\limits_{T_0}^{TL} \int\limits_{T_0}^{R} k(T) dT}{(T_L - T_0)} \qquad \Longrightarrow \qquad R_I = \frac{L}{k_{AV}A} \qquad \dot{q} = -\frac{A}{L} \int\limits_{T_0}^{T_L} k(T) dT = \frac{T_0 - T_L}{R_I}$$

In both cases we can recognize an analogy with the electrical resistance (replace q with I, T with V):

$$I = \frac{V_0 - V_L}{R}$$

We can therefore model a complex thermal conductivity problem by elementary thermal resistances Ri, and solve the network by using Kirckhoff's laws.

$$\sum_{i=0}^{n} \dot{q}_{i} = 0 \quad (at \, knots)$$

$$\sum_{i=1}^{n} \dot{q}_{i} = 0 \quad (at \; knots)$$

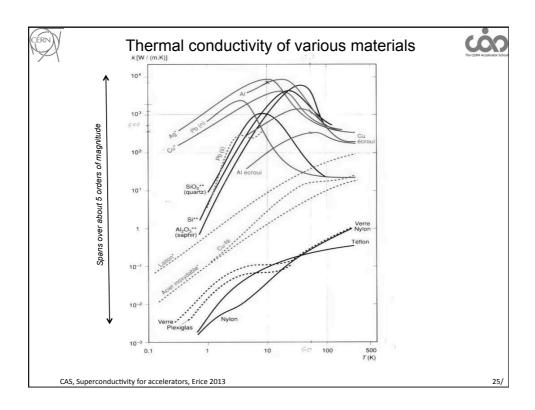
$$\sum_{i=1}^{m} (T_{i} - T_{i-1}) = 0 \quad (in \; loops)$$

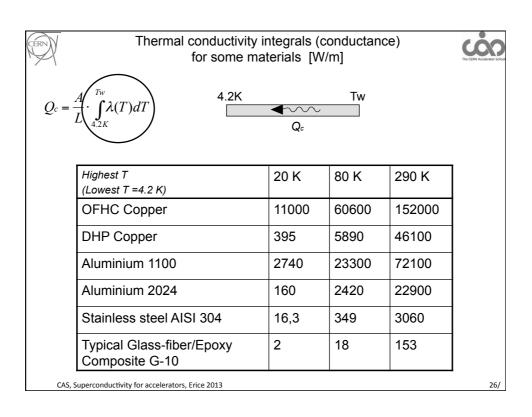
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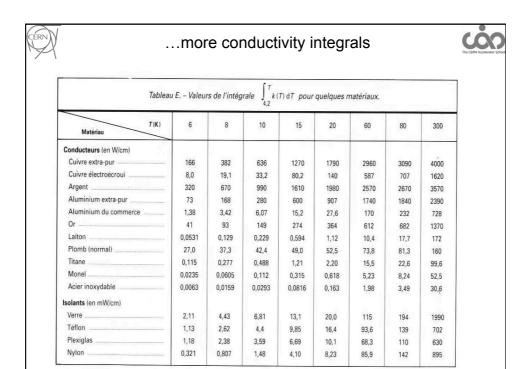


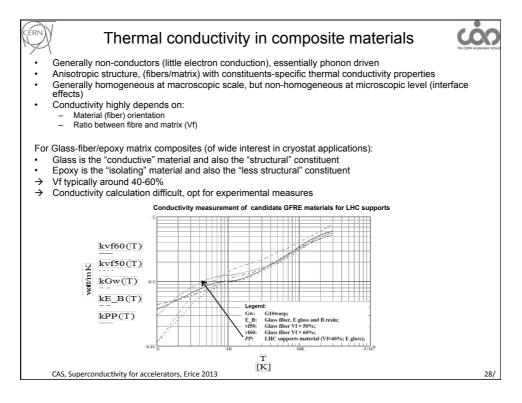


Thermal conductivity data for selected materials





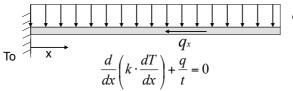




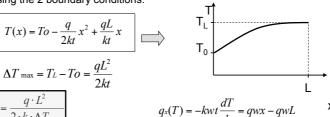


Thermal conduction with uniform heat deposition





- · Beam of length L, thickness t, width w;
- beam thermalized on one side at To
- uniform heat deposition from one side, q (W/m2)
- · considering k constant with T
- Boundary conditions: a) for x= 0 T=To (heat sink); b) q=0 for x=L (isolated tip)
- Integrating and imposing the 2 boundary conditions:



practical interest: calculate thickness of a thermal shield

tical interest: value thickness thermal shield
$$t = \frac{q \cdot L^2}{2 \cdot k \cdot \Delta T_{\max}}$$
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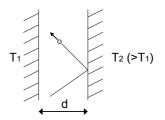
Residual Gas Conduction



λmolecule << d → Viscous regime Amolecule >> d → Molecular regime

Viscous regime:

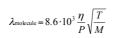
- At High gas pressure
- Classical conduction (q = -A k(T) dT/dx) with k independent of pressure
- but natural convection must be included



 λ molecule = mean free path

Molecular regime:

- At low gas pressure
- Kennard's law
- Conduction is proportional to P
- Ω depends on gas species (for helium Ω = 2.13 W/m2.Pa.K)
- $\alpha(T) \Rightarrow accommodation coefficient$ surface geometry (applicable for flat spheres)



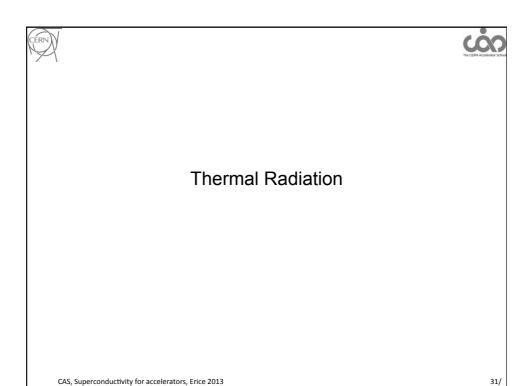
- η = gas viscosity in poises
 P = pressure in micometers of mercury, μHg

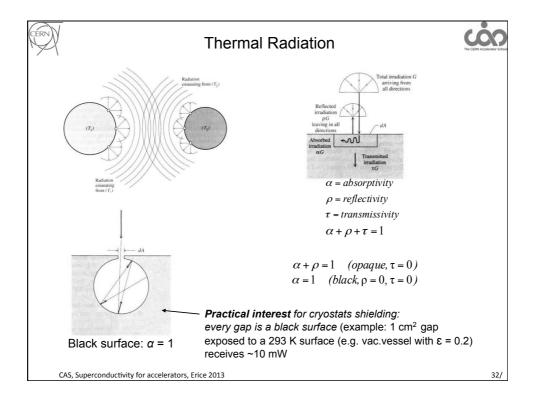
- $Q_{res} = A_1 \cdot \alpha(T) \cdot \Omega \cdot P \cdot (T_2 T_1)$

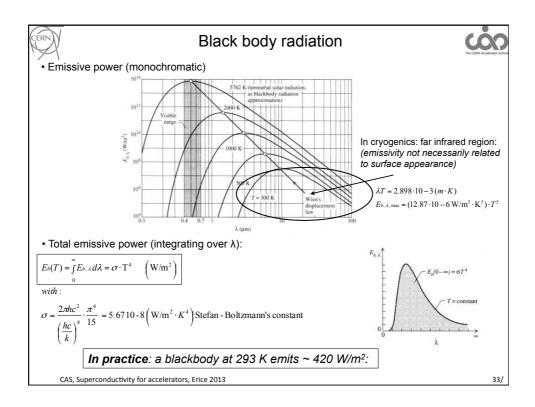
depending on gas species, T1, T2 and parallel surfaces, coaxial cylinders and

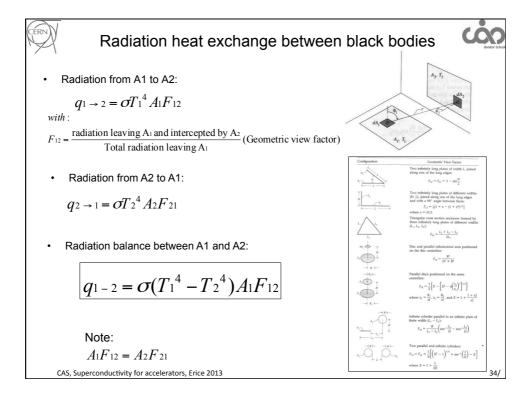
 $\alpha_1\alpha_2$ $\frac{\alpha_2 + \alpha_1(1 - \alpha_2) \frac{A_1}{A_2}}{\alpha_2 + \alpha_1(1 - \alpha_2) \frac{A_1}{A_2}}$

Temp. [K] Helium 80 0.4 20 0.6 1





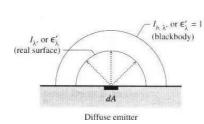


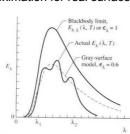


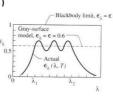


Non-black surfaces: the diffuse-gray model (real surfaces

Diffuse-gray emitter (good approximation for real surfaces)







Total hemispheric emissivity:

$$\varepsilon(T) = \frac{E(T)}{E_b(T)} \le 1$$

(Note: @ cryo temp. ε is strongly T dependent)

- Similar considerations can be made for adsorptivity and reflectivity
- The Diffuse-gray model:
 - Gray
 - A diffuse emitter, absorber and reflector
 - Opaque (no transmittivity)

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Emissivity of various materials as a function of T



Temperature [K]	4	20	80	300
Copper mechanically polished	0.02		0.06	0.1
Copper black oxidized				0.8
Gold			0.01	0.02
Silver	0.005		0.01	0.02
Aluminium electropolished	0.04		0.08	0.15
Aluminium mechanically polished	0.06		0.1	0.2
Aluminium with 7µm oxide				0.75
Magnesium				0.07
Chromium			0.08	0.08
Nickel			0.022	0.04
Rhodium			0.08	
Lead	0.012		0.036	0.05
Tin	0.012		0.013	0.05
Zinc			0.026	0.05
Brass, polished	0.018		0.029	0.035
St.steel 18-8	0.1		0.12	0.2
Glass	0.1			0.94
Ice				0.96
Oil paints any color				0.92-0.96
Silver plate on copper		0.013	0.017	
Aluminium film 400A on Mylar			0.009	0.025
Aluminium film 200A on Mylar			0.015	0.035
Nickel coating on copper		0.027	0.033	

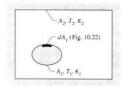
(R.B. Scott, Cryogenic Engineering, (Van Nostrand, New York, 1959; Y.S. Touloukian, Thermophysical Properties of Matter, (Plenum Press, New York, 1995))

- Strong T dependence (quasi proportional to T) Emissivity reduces with T
- At cryogenic temperatures low emissivity in the far infrared is not necessarily related to surface brilliance



Radiation between 2 diffuse-gray enclosures



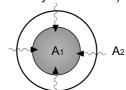


Radiation balance between A1 and A2:

$$q_{1-2} = \frac{\sigma(T_1^4 - T_2^4)}{\frac{1 - \varepsilon_1}{\varepsilon_1 A_1} + \frac{1}{A_1 F_{12}} + \frac{1 - \varepsilon_2}{\varepsilon_2 A_2}}$$

• For 2 enclosed cylinders or spheres (not necessarily concentric!):

$$q_{1-2} = \frac{\sigma A_1(T_2^4 - T_1^4)}{\frac{1}{\varepsilon_1} + \frac{A_1}{A_2} \left(\frac{1}{\varepsilon_2} - 1\right)}$$



To reduce heat load to inner surface (cryostat case):

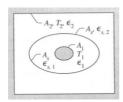
- Reduce A2 (vac.vessel as small as possible)
- Small emissivities: ε1 reduced by low T; ε2 at RT & moderated by A1/A2

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Radiation with an intermediate floating shield





• Radiation balance between A1 and A2:

$$q_{1-2} = \frac{\sigma(T_1^4 - T_2^4)}{\frac{1-\varepsilon_1}{\varepsilon_1 A_1} + \frac{1}{A_1 F_{1s}} + \frac{1-\varepsilon_{s,1}}{\varepsilon_{s,1} A_s} + \frac{1-\varepsilon_{s,2}}{\varepsilon_{s,2} A_s} + \frac{1}{A_s F_{s2}} + \frac{1-\varepsilon_2}{\varepsilon_2 A_2}}$$
A1 to S gap S to A2 gap

• For flat surfaces approximation, and same ϵ :

$$q_{1-2} = \frac{\sigma(T_1^4 - T_2^4)}{2(\varepsilon^2 - 1)}$$

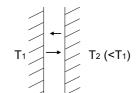
→ ½ of the rate without shield



Radiation between 2 diffuse-gray flat plates



Radiation balance between A1 and A2 (A1=A2=A):



$$q_{1-2} = \frac{\sigma A(T_1^4 - T_2^4)}{\frac{1}{\varepsilon_1} + \frac{1}{\varepsilon_2} - 1}$$

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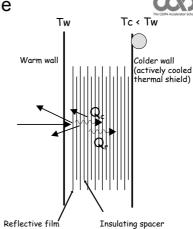
Multi Layer Insulation (MLI)



MLI principle



- Low emissivity of aluminium layer
- Multi-layer to enhance radiation protection:
 - multi reflection of radiation...
- Minimal thermal conductivity between reflective layers: interposing of isolating
 - Reduced inter-layer thermal conduction heat loads
- Enhanced performance @ low T → use actively cooled shield
 - Lower emissivity of reflective material layers @ low T
 - Reduce radiation from inner-most layers, cooled at T of shield
 - Extract heat @ thermal shield T → more efficient heat extraction



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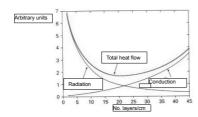
MLI:

How many reflective layers (N)?



Radiation vs. conduction, two conflicting phenomena

- Radiation reduces as 1/N
- Conduction is proportional to packing density (N/mm)



- Packing density should be limited → typically ~ 25 N/cm
 - > Avoid "compressed" blankets, do not put as much MLI as possible...
 - > Do not forget space allocation for MLI blankets
 - > Consider differential thermal contractions wrt support (Al shields, cold mass...): blankets must remain loose at cold



Multi Layer Insulation (MLI): a simplified calculation model

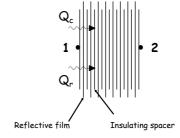


- · A simplified model:
 - Radiation reduction
 - Solid conduction

$$Q_{ML}\dot{f} = \left[\frac{\beta}{N+1} \cdot \left({T_1}^4 - {T_2}^4\right)\right] + \frac{\alpha}{N+1} \cdot \frac{T_1 + T_2}{2} \cdot (T_1 - T_2)$$

N = No. of reflective layers $\alpha,\,\beta$ = average thermal conductivity and emissivity constants of the MLI system (obtained experimentally. For LHC cryostats: α =1.401 10-4, β =3.741 10-9)





Considering the complexity of the phenomena Involved, an experimental characterisation of MLI performance, in particular for large machines, **must** be made. However, abundant literature data available.

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LHC Multi Layer Insulation (MLI)



Features

1 blanket (10 reflective layers) on cold masses (1.9 K)

2 blankets (15 reflective layers each) on Thermal Shields (50-65 K) Reflective layer: double aluminized polyester film

Spacer: polyester net

Stitched Velcro™ fasteners for rapid mounting and quality closing

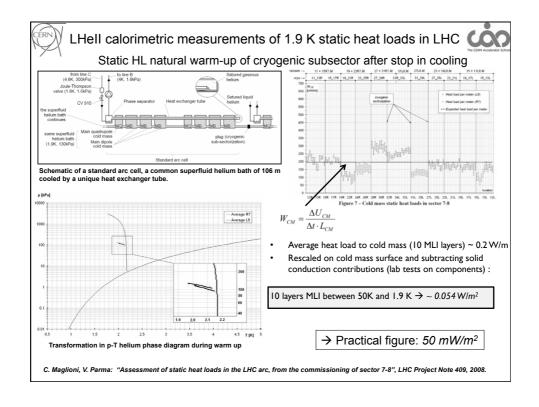


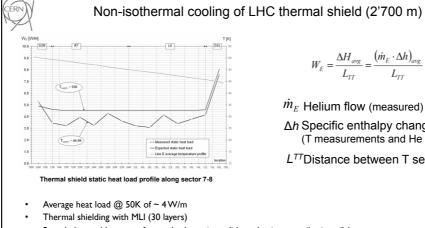




Measured thermal performance on LHC

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$W_E = \frac{\Delta H_{\text{avg}}}{L_{TT}} = \frac{\left(\dot{m}_E \cdot \Delta h\right)_{\text{avg}}}{L_{TT}} \quad \text{[W/m]}$

 $\dot{m}_{\scriptscriptstyle E}$ Helium flow (measured)

Δh Specific enthalpy change (T measurements and He properties)

 L^{TT} Distance between T sensors

Rescaled on cold mass surface and subtracting solid conduction contributions (lab tests on components):

30 layers MLI between 300K and 50 K $\rightarrow \sim 1 \text{ W/m}^2$

→ Practical figure: 1 W/m²





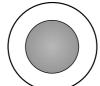
Numerical application on the LHC Cryostat



Application to an LHC-like cryostat



- heat loads HL will be calculated for a 1-m cryostat unit length
- Vacuum vessel diameter: 1m (A_{VV} = π x 1= 3.14 m²)
- Cold mass diameter: 0.6 m (A_{CM}= π x 0.6 = 1.88 m²)
- T cold mass: 2 K
- T vac.vessel: 293 K
- Budgets: $HL_{CM} \sim 0.2 \text{ W/m}$; $HL_{TS} \sim 5 \text{ W/m}$



$$Q = \frac{\sigma A_{CM} (T_{VV}^4 - T_{CM}^4)}{\frac{1}{\varepsilon_{CM}} + \frac{A_{CM}}{A_{VV}} \left(\frac{1}{\varepsilon_{VV}} - 1\right)}$$

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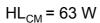
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a) Bare cold mass



- Emissivity cold mass: $\varepsilon_{CM} = 0.12$
- Emissivity vac.vessel: ε_{VV} = 0.2



Budget for LHC is ~0.2 W → HL too high

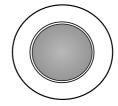
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b) Cold mass wrapped with 1 layer of Al foil



Emissivity of AI foil (at 2 K): ϵ_{CM} = 0.06



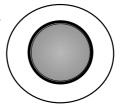
 HL_{CM} = 40 W \rightarrow HL still too high



c) Cold mass wrapped with 30 layers of MLI



HL from 290 K with 30 MLI layers (calculated with MLI formula):



 $HL_{CM} = 1.2x1.88 = 2.3 W$

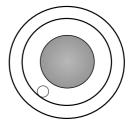
→ HL still 1 order of magnitude too high



d) Addition of thermal shield actively cooled



- Thermal shield diameter: 0.8 m (A_{TH} = = π x 0.8 = 2.51 m²)
- Thermal shield at intermediate T → 80 K
- Emissivity of AI (at 80 K): ε_{TS} = 0.1



 $HL_{CM} = 0.26 \text{ W} \rightarrow \text{Close to budget}$

 $HL_{TS} = 79 \text{ W} \rightarrow \text{too high (Budget for LHC is 5 W)}$

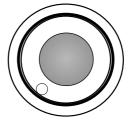
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e) Wrapping of MLI around thermal shield



HL from 290 K with 30 MLI layers 1 W/m²



 $HL_{CM} = 0.26 W$

→ Close to budget

 $HL_{TS} = 1x2.51 = 2.51 W$

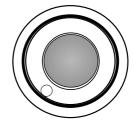
→Within budget for LHC (5 W)



f) Adding 1 Al foil around cold mass



Emissivity of AI foil (at 2 K): ϵ_{CM} = 0.06



$$HL_{CM} = 0.18 \text{ W}$$

→ within budget (0.2 W)

$$HL_{TS} = 2.51 \text{ W}$$

→Within budget (5 W)



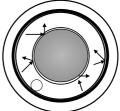
g) What in case of bad vacuum (He leaks)?



→ Residual gas molecular conduction:

$$Q_{res} = A_1 \cdot \alpha(T) \cdot \Omega \cdot P \cdot (T_2 - T_1)$$

$$\alpha = \frac{\alpha_1 \alpha_2}{\alpha_2 + \alpha_1 (1 - \alpha_2) \frac{A_1}{A_2}}$$



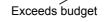
- From table, for He at 2 K: α_{CM} =1, for He at 80K α_{TH} =0.4 \rightarrow α = 0.47
- for He, Ω = 2.13 W/m².Pa.K
- For 1 Al foil on cold mass, in case of degraded vacuum:

$$Q = Q_{rad} + Q_{res}$$

For P = 1 mPa: (still quite good vacuum)

$$Q_{res} = \underline{0.15W}$$
 $Q = Q_{rad} + Q_{res} = 0.18 + 0.15 = \underline{0.33W}$

For P = 100 mPa:



 $Q_{res} = 15W$ (degraded vacuum)

2 orders or magnitude higher than budget!!



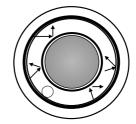
h) Add MLI around the cold mass



- 10 MLI layers on cold mass
- · Using measured data
 - In good vacuum (<1mPa): 50 mW/m²

$$HL_{CM} = 1.88 \times 0.05 = 0.09 \text{ W}$$

($HL_{TS} = 3.59 \text{ W}$)



HL even lower

- Under degraded vacuum (~100 mPa): ~2W/m²

Important note: MLI on helium vessels also necessary to reduce by about 7 condensation heat fluxes in case of accidental cryostat venting with air (bare surface: $q \sim 4 \text{ W/cm}^2$; 10 layers of MLI: $q \sim 0.6 \text{ W/cm}^2$)

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Summarizing



Case	2K heat loads	80 K heat loads
a) Bare Cold mass	63 W	N.A.
b) Cold mass with 1 Al foil	40 W	N.A.
c) Cold mass with 30 MLI layers	2.3 W	N.A.
d) 1 thermal shield at 80K, no MLI	0.26 W	79 W
e) 30 MLI layers on thermal shield	0.26 W	2.51 W
f) As e) + 1 Al foil on cold mass	0.18 W	2.51 W
g) As f) but degraded vacuum	up to 15 W (100 mPa)	> 2.51 W
h) +10 MLI layers on cold mass	0.09 W in good vac. 3.5 W in deg.vac.	3.59 W > 3.59

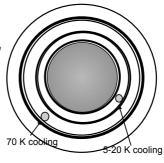
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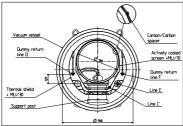


What about a second actively cooled shield?



- Experimental program for LHC cryostat in the late nineties (Cryostat Thermal Model, CTM)
- A 10 K active cooled screen with 10 MLI layers
- An estimated (tests far from simple!) saving of about 0.15 W/ m at 1.9 K
- but the an equivalent increase at the 5-20 K level (~5 times
- Overall electrical power saving: ~ 100 Wel/m
- Additional hardware (line, MLI, supports,etc) → higher capital cost
- Additional assembly complexity
- Breakeven only after ~10 years of operation
- For LHC it was decided to keep 1 active shield at 70K





The Cryostat Thermal Model

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Thermal shield: what thickness?



- Aluminium shield, in Al 5052
- Actively cooled by 1 cryo line at 80K
- → Average conductivity: k = 80 W K⁻¹m⁻¹
- Uniform heat deposition:

 HL_{TS} = 3.59 W \rightarrow q = 3.59/(0.8x1x π) = 1.43 W/m²

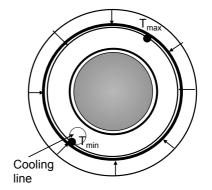
Calculate thickness with the requirement:

Azimuthally quasi iso-thermal shield:

-
$$\Delta T_{\text{max}}$$
= T_{max} - T_{min} ≈ 5 K

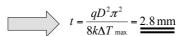
Remembering the formula yielding $\Delta T_{\text{max}}\!\!:$

$$\Delta T_{\text{max}} = \frac{qL^2}{2kt}$$

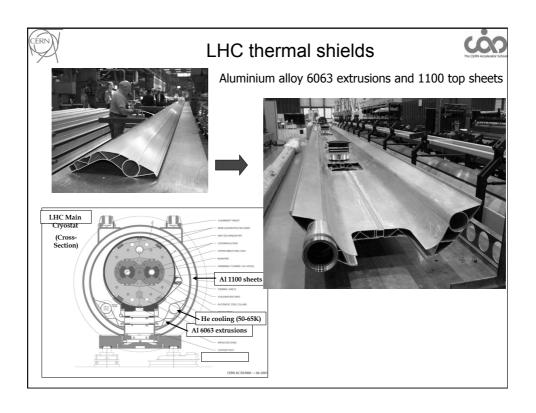


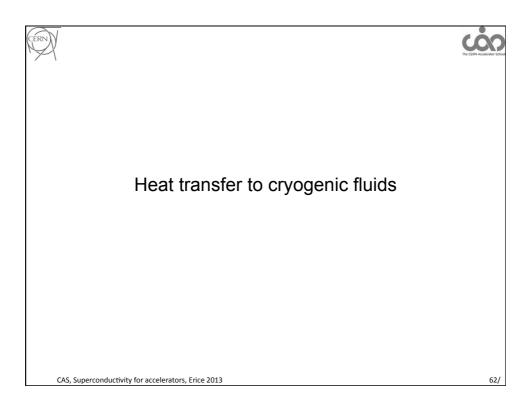
Replacing L by ½ circumference of diameter D (Tmax opposite to cryo

$$\Delta T_{\text{max}} = \frac{qD^2\pi^2}{8kt}$$



(for LHC, 2.5mm thick AI 1100 equivalent)



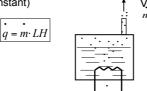




2 main mechanisms of interest for cryostats

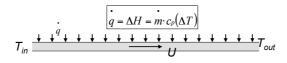


- · Vaporisation in pool boiling (2-phase)
 - Latent Heat (LH) of vaporisation
 - Isothermal cooling (T constant if P constant)



vaporisation under 1 vv neat load				
Cryogen	Latent Heat (at 1tm) [kJ/kg]	[mg/s]	[l/h] (liquid)	[l/min] (gas NTP)
Helium	21	48	1.38	16.4
Nitrogen	199	5	0.02	0.24

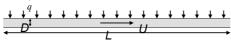
- · Forced internal (tube) convection of single-phase fluid:
 - Non-isothermal cooling: enthalpy change of fluid
 - Depends from thermo-hydraulics of the flow (see next slide)
 - Used in cooling of thermal shields (supercritical He)



For conduction in superfluid helium see dedicated course



Forced Convection Heat Transfer





- Forced flow of coolant fluid in round tube cooling lines
- Considering hydro-dynamically and thermally fully developed flow
- Uniform wall heat flux (linear T profiles)

Case of a Thermal Shield

• Convection heat transfer from wall to fluid:

$$q = h \cdot D\pi L \cdot (T_w - T_m)$$

 T_w = wall temperature T_m = mean temperature

• Enthalpy balance along the line L:

$$q = m \cdot c_p \cdot (T_{out} - T_{in})$$

m = mass flow[kg/s]

 $q = m \cdot c_p \cdot (T_c)$

T_{out} = fluid exit temperature
T_{in} = fluid entrance temperature

• Reynolds No.:

$$\int_{M_{\rm HD}} \frac{1}{v} h \cdot D$$

v = kinematic viscosity (μ/ρ) Rep>2000 \rightarrow turbulent flow, Rep<2000 \rightarrow laminar flow

• Nusselt No.:

$$Nu_D = \frac{h \cdot D}{k}$$

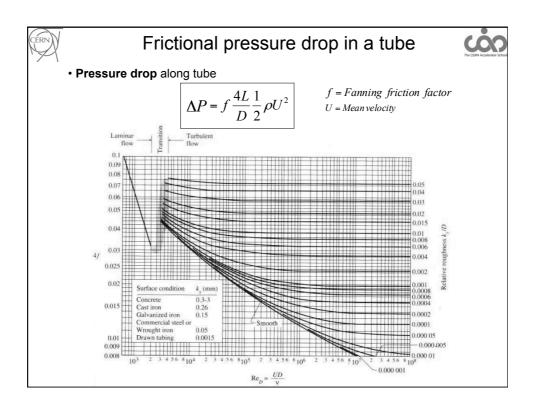
- k = therm. conductivity
- For **laminar flow**: Nu_D
- $\frac{dT_m}{dx} = \frac{4}{D} \cdot \frac{\dot{q}}{\rho c_p U}$
- For turbulent flow, Nup=f(ReD, Pr):

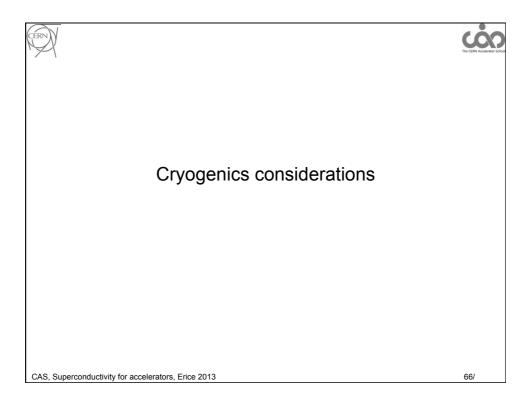
for heated fluid; 0.7 ≤ Pr ≤ 120 2500 ≤ Rep ≤ 1.2410 + 5

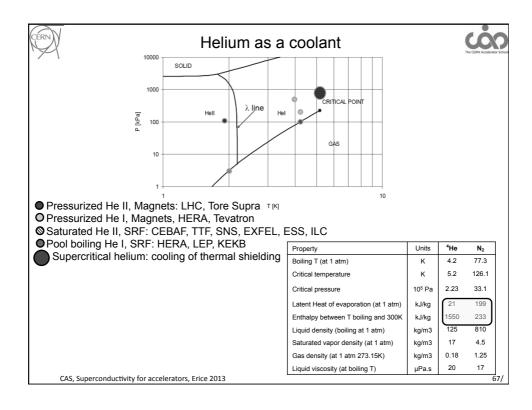
 $Nu_D = 0.023 \cdot \text{Re}_D^{4/5} \text{Pr}^{2/5}$

$$Pr = \frac{v}{c}$$

 α = thermal diffusivity



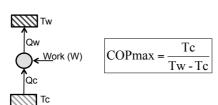


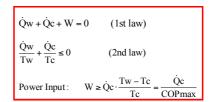


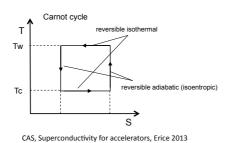
Refrigeration efficiency (Carnot principle)



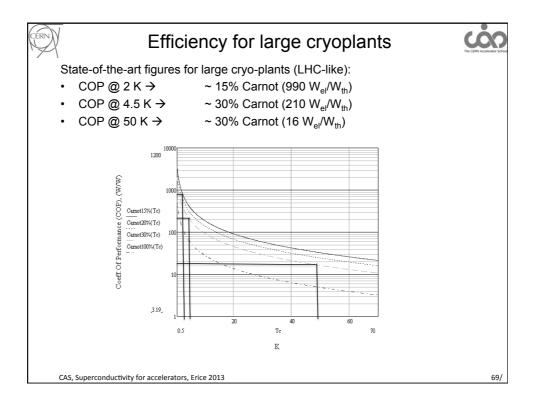
- A refrigerator extracts a heat flow at a temperature below ambient and rejects it at a higher temperature (normally ambient)
- The Carnot cycle defines the minimum mechanical work/power (i.e. Maximum Coefficient of Performance, COP) which depends only on Tw and Tc
- · All real machines have a lower efficiency (irreversibilities), expressed in fraction of COP

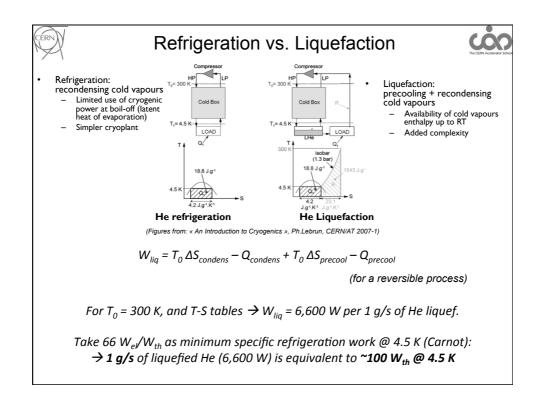






Fluid	T [K]	Carnot factor (W/Qc) [W/W]
LN2	77	2.8
LH2	20.4	13.4
LHe	4.2	68.4
LHe	1.8	161.8



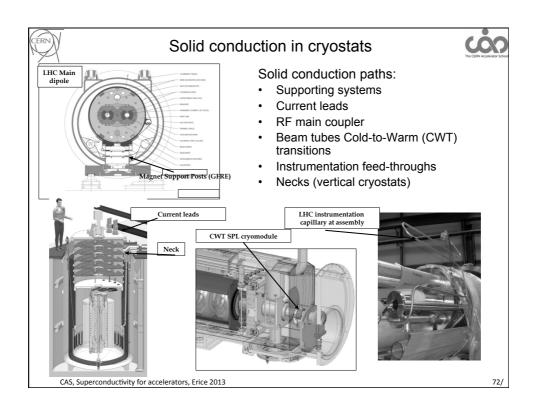


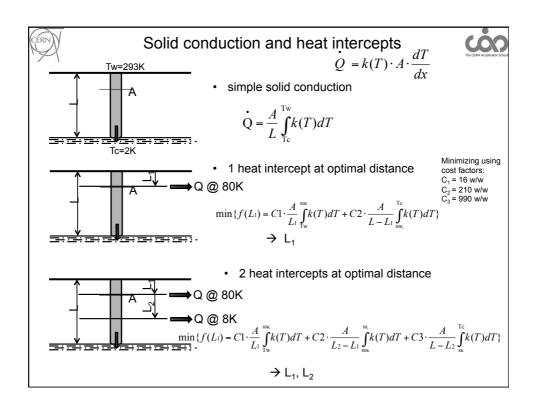


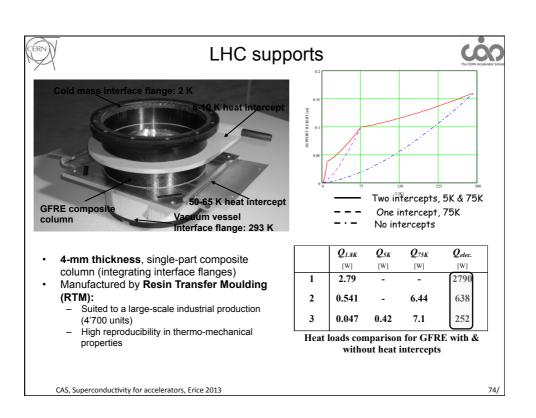


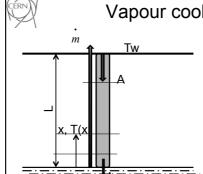
Thermally efficiency solid conduction: heat intercepts, vapour helium cooling

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Vapour cooling in solid conduction



- · Vapour cooled wall
- Assuming perfect exchange (T gas = T wall)

$$k(T) \cdot A \cdot \frac{dT}{dx} = \stackrel{\cdot}{Q} + m Cp \cdot (T - T_l)$$

• If Q, which is the residual heat to the bath, is equivalent to the evaporation (i.e. self-sustained):

$$\rightarrow Q = m \cdot Lv$$
 Lv, latent heat of evap.

attenuation factor (w.r.t. solid conduction)

$$\dot{Q} = \frac{A}{L} \cdot \int_{\text{Tr}}^{\text{Tw}} \frac{k(T)}{1 + \frac{(T - T_l) \cdot Cp}{Lv}} dT$$

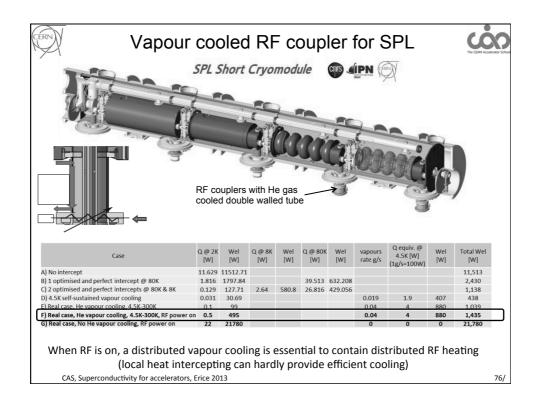
Reduced heat conduction in self-sustained helium cooling for selected technical materials

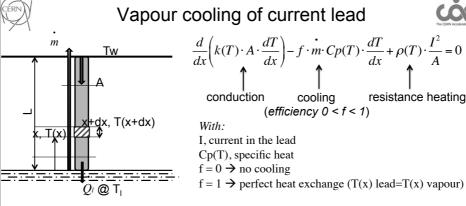
	Thermal conductivity integral [W cm ⁻¹]	Effective thermal conductivity integral [W cm ⁻¹]
ETP copper	1620	128
OFHC copper	1520	110
Aluminium 1100	728	39.9
AISI 300 st.steel	30.6	0.92

Large enthalpy in He vapours (1550 kJ/kg from 4.2K to 300K) → usable cooling capacity

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 $Q \otimes T_1$





For current lead material following the Wiedmann-Franz law (most metals and allows, Cu for example):

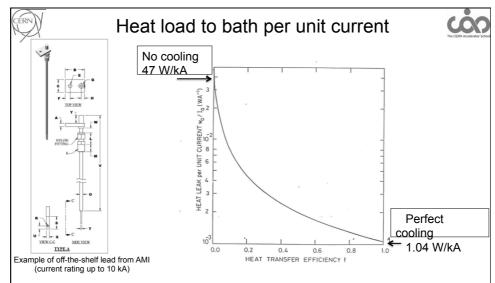
$$\rho(T) \cdot k(T) = Lo \cdot T$$

$$Lo = 2.45 \cdot 10^{-8} \left(\frac{V_K}{K}\right)^2$$
(Constant for most metals and alloys)

- $\varrho(T)$ and k(T) are correlated! (good electrical conductors are also good thermal conductors)
- · Minimising heat in-leaks is independent of material choice for normal conducting materials

Substituting in the above equation and integrating it for variable f efficiencies...(next slide) CAS, Superconductivity for accelerators, Erice 2013

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- Enhancing thermal performance can be achieved with materials which do not follow the WF law
- High Temperature Superconductors, for example, have zero resistivity and are relatively bad thermal conductors up to high temperatures.

 more in specific lecture

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End of 1st Part...

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Insulation vacuum and construction aspects

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Leaks



Units:

• A leak is a throughput, normally given symbol $q_{\scriptscriptstyle L}$

$$q_L = q_{pV} = \frac{pV}{t} = \frac{n}{t}RT = \frac{m}{t}.\frac{RT}{M}$$

- · Common units are:
 - mbar.l/s atm.cc/s torr.l/s Pa.m3/s (SI unit)
 - With a leak rate of 1 mbar.l/s a volume of 1 litre will change in pressure by 1 mbar in 1 second
 - Units of mbar.l/s equivalent to atm.cc/s

Eg immersed in water:

- A leak of 1 atm.cc/s would produce a bubble of 1 cm³/s
- A leak of 10-3 atm.cc/s would produce a bubble of 1 mm³/s
- Flux through a leak will be different depending on the prevailing conditions (temperature, pressure, gas type)
- Unless otherwise stated, a 'standard helium leak rate' in mbar.l/s implies:
 - Helium as tracer gas,
 - Under vacuum test,
 - $-\;$ Helium at 1 bar_{abs} and 100% concentration
 - System at 20 °C.

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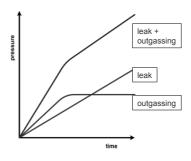
Leak tightness



- · No vacuum vessel is leak-tight, nor should it be
- Define the satisfactory leak rate needed to remain within the needed pressure:

$$q_L = \frac{\Delta p \cdot V}{\Delta t}$$

Normally 2 sources of pressure increase: leaks and outgassing

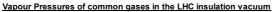


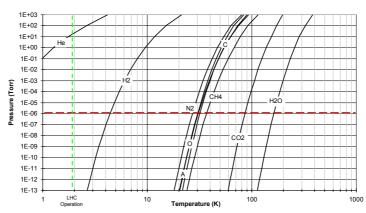
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Cryopumping: cryo-condensation







- 2-4.5 K surfaces have high pumping speed & capacity
- Gas species have very low saturation vapour pressure except helium
- Without helium leaks, equilibrium pressures < 10-6 mbar are obtained

→ helium leaks are the real issue

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MLI outgassing



Outgassing of Multilayer Insulation Film and Spacer

- PET, 12E-6 m thick, Corona discharge on one side, REXOR, 1265 mm wide, Sample 1

 PET, 12E-6 m thick, Corona discharge on one side, REXOR, 1015 mm wide, Sample 7

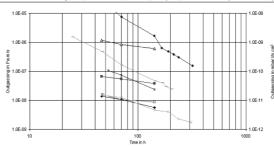
 SAM, 12E-6 m thick, LYDALL, Sample 6

 Glassfibre Tissu Spacer, Cryotherm 243, LYDALL, Sample 3

 Polyester mesh spacer, Tulle, BILLON, Sample 4

 Double aluminized Poliminic 25F-8 m thick TDPCON Sample 9

- Double aluminized Polyimide, 25 E-6 m thick, TRICON, Sample 8
 Double aluminized Polyimide, 25 E-6 m thick, TRICON, Sample 8, after bake and exposure to atmosphere



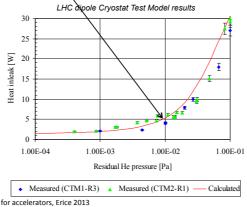
- Outgassing in cryostats is normally dominated by MLI outgassing
- For an LHC insulation vacuum sector (80 m³, 250 m²/m length of MLI, 214m length) exposed to ambient air for several weeks, we obtain ~ 1 e-3 mbar at RT after ~ 200 hrs pumping (S = 100 l/s). Equivalent to ~ 2 e-10 mbar.l/s/cm2 of MLI.



Insulation vacuum and heat loads from residual gas conduction



- Insulation vacuum is about minimising heat transfer due to residual gas conduction (wrt to radiative and conductive heat transfer)
- Only helium leaks can degrade the vacuum
- Determine the maximum acceptable degraded helium pressure for cryostat (only helium matters for LHC)
 - For LHC → ~ 10-4 mbar (10-2 Pa)



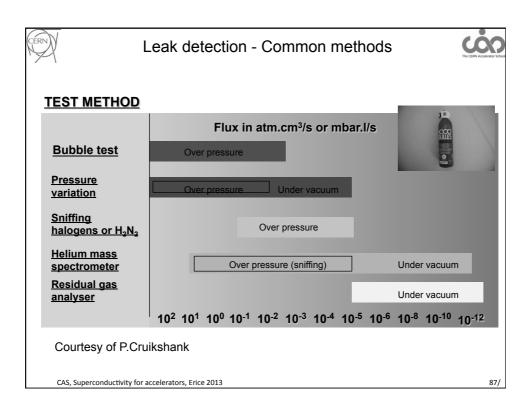
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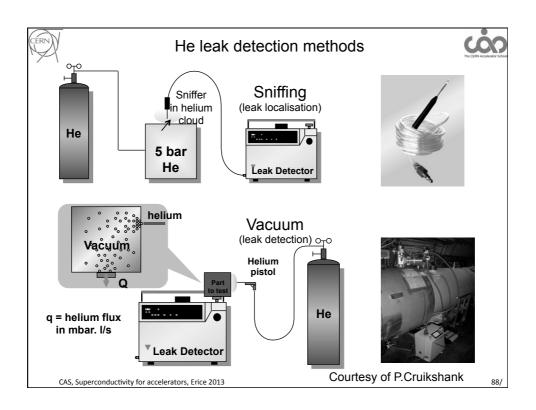


LHC Strategy

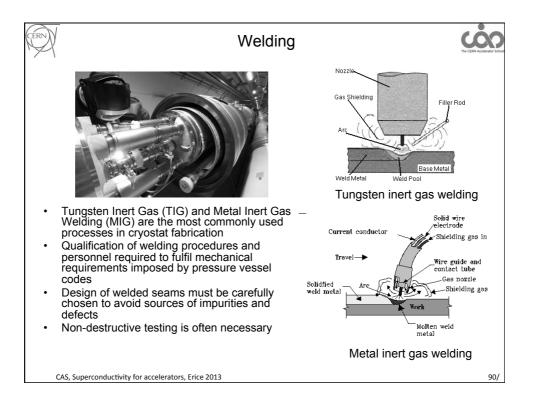


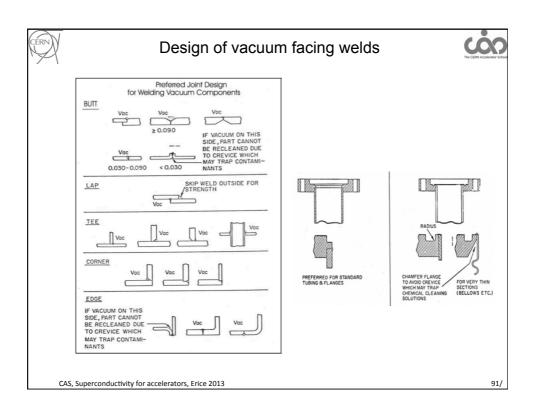
- Consider no mechanical pumping on insulation vacuum during operation
- Determine maximum helium degraded vacuum pressure → 10-2 Pa
- Determine helium cryosorption capacity of cold surfaces
 - For LHC ~ 100 mbar.l of helium @ 1 e-4 mbar per 214 m of cryostat
- Determine the leak rate that will saturate the cold surfaces of 1vacuum sector after 200 days of LHC operation → < 5 10-6 mbar.l/s
- Use fixed turbos during thermal cycles and as 'backup' in case the tightness specification cannot be immediately reached
- Apply cold/warm correlation for leak rates (considered to be up to x1000 at cold) → < 5 10-9 mbar.l/s per vacuum sector
- Allocate higher levels of leak tightness to sub-assemblies and components in one same vacuum sector → down to < 10-11 mbar.l/s
- → These very low levels of leak tightness on steel metal work and welded piping assemblies are extremely challenging for construction and testing, especially for large industrial productions (e.g. LHC)

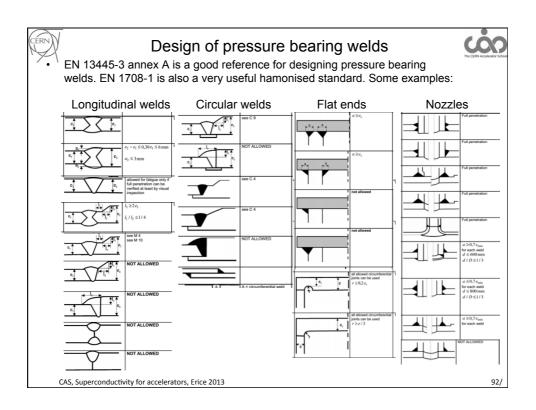












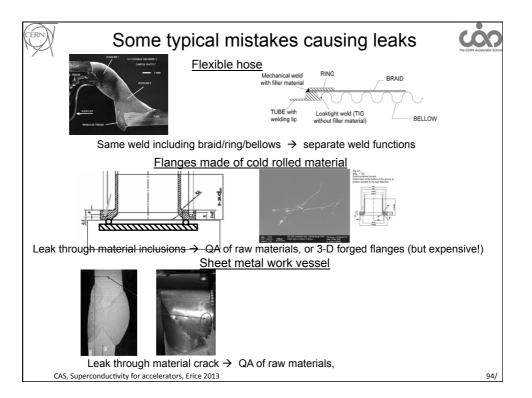


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Welders and procedures qualification



	Steel	Aluminium	
Welding procedure	EN ISO 15614-1:2004	EN ISO 15614-2:2005	
approval	Specification and	Specification and	
	qualification of welding	qualification of welding	
	procedures for metallic	procedures for metallic	
	materials - Welding	materials - Welding	
	procedure test - Arc and	procedure test - Arc	
	gas welding of steels and	welding of aluminium and	
	arc welding of nickel and nickel alloys	its alloys	
Qualification of welders	EN 287-1:2004 Qualification	EN ISO 9606-2:2004	
	test of welders - Fusion	Qualification test of	
	welding - Steels	welders - Fusion welding -	
		Aluminium and aluminium	
		alloys	
Qualification of welding EN 1418:1998 Welding personnel - Approval test		nnel - Approval testing of	
operators	welding operators for fusion welding and resistance weld		
	setters for fully mechanized and automatic welding of metallic materials		





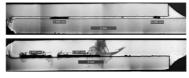
Brazing



- Often the only solution to join different materials (ex: copper to stainless steel; stainless steel to ceramics...)
- Vacuum brazing (no flux required) gives the most reliable joints, but at a cost
- Thorough cleaning after brazing with flux is mandatory. Poor cleaning often results in the development of leaks in stainless steel due to corrosion!
- Useful standards for brazing specification and execution:

Example of flame brazed stainless steel to copper transition for a thermal shield cooling circuit





- EN 13134:2000 Brazing Procedure approval
- EN 13133:2000 Brazing Brazer approval
- EN 12797:2000 Brazing Destructive tests of brazed joints
- EN 12799:2000 Brazing Non-destructive examination of brazed joints
- EN ISO 18279:2003 Brazing Imperfections in brazed joints

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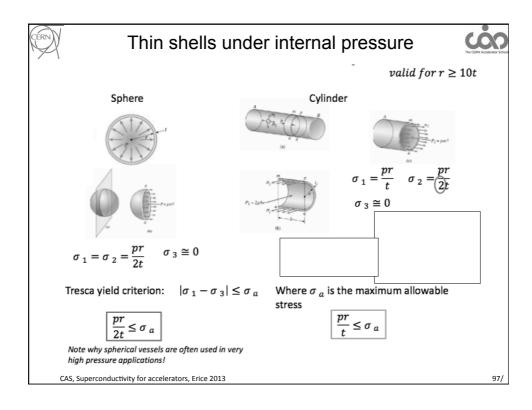
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Mechanical considerations

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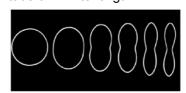


Radial buckling under external pressure



- Non-linear phenomenon. Actual critical pressure depends on initial imperfections: Safety factor needed!
- · Buckling critical pressure for a thin tube of infinite length

$$p_{cr} = \frac{E}{4(1-v^2)} \left(\frac{t}{r}\right)^3$$



• A conservative rule of thumb for stainless steel tubes under vacuum:

$$\frac{t}{r} \ge \sqrt[3]{\frac{0.1MPa \times 4 \times (1 - 0.3^2)}{200 \times 10^3 MPa}} = 0.012$$

• If we use a safety factor of 3:

$$\frac{t}{r} \ge 3.7\%$$

· Alternatively, we need to add reinforcements

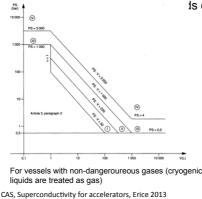
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Pressure vessel codes regulations



- Pressure European Directive 97/23/EC (PED) is obligaory throughout the EU since 2002
 - Applies to internal pressure ≥ 0.5 bar
 - Vessels must be designed, fabricated and tested according to the essential requirements of Annex I (Design, safety accessories, materials, manufacturing, testing, etc)
 - Establishes the conformity assessment procedure depending on vassel
 is on the stored energy expressed as



Catego ry	Conf. assessment module	Comment
SEP	None	The equipment must be designed and manufactured in accordance with sound engineering practice. No CE marking and no involvement of notified body.
I	A	CE marking with no notified body involvement, self-certifying.
II	A1	The notified body will perform unexpected visits and monitor final assessment.
III	B1+F	The notified body is required to approve the design, examine and test the vessel.
IV	G	Even further involvement of the notified body.

CERN

Harmonised codes and standards



- Harmonised standards give presumption of comformity with the PED, within their scope. Uselful codes for cryostat design and fabrication:
 - EN 13458-1:2002 Cryogenic vessels Static vacuum insulated vessels Part 1: Fundamental requirements
 - EN 13458-2:2002 Cryogenic vessels Static vacuum insulated vessels Part 2: Design, fabrication, inspection and testing + EN 13458-2:2002/AC:2006
 - EN 13458-3:2003 Cryogenic vessels Static vacuum insulated vessels Part 3:
 Operational requirements + EN 13458-3:2003/A1:2005
 - EN 13445-1:2009 Unfired pressure vessels Part 1: General
 - EN 13445-2:2009 Unfired pressure vessels Part 2: Materials
 - EN 13445-3:2009 Unfired pressure vessels Part 3: Design
 - EN 13445-4:2009 Unfired pressure vessels Part 4: Fabrication
 - EN 13445-5:2009 Unfired pressure vessels Part 5: Inspection and testing
 - EN 13445-8:2009 Unfired pressure vessels Part 8: Additional requirements for pressure vessels of aluminium and aluminium alloys
- Other codes such as the French CODAP or the American ASME Boiler and Pressure Vessel Code can be used, but proof of comformity is at the charge of the manufacturer.

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Useful material standards for cryostats



Plates and sheets	 EN 10028-1:2007+A1:2009 Flat products made of steels for pressure purposes - Part 1: General requirements
	 EN 10028-3:2009 Flat products made of steels for pressure purposes - Part 3: Weldable fine grain steels, normalized
	 EN 10028-7:2007 Flat products made of steels for pressure purposes - Part 7: Stainless steels
Tubes	EN 10216-5:2004 Seamless steel tubes for pressure purposes - Technical delivery conditions - Part 5: Stainless steel tubes
	 EN 10217-7:2005 Welded steel tubes for pressure purposes - Technical delivery conditions - Part 7: Stainless steel tubes
Forged blanks	 EN 10222-1:1998 Steel forgings for pressure purposes - Part 1: General requirements for open die forgings
	 EN 10222-5:1999 Steel forgings for pressure purposes - Part 5: Martensitic, austenitic and austenitic-ferritic stainless steels
Castings	EN 10213:2007 Steel castings for pressure purposes
Pipe fittings	 EN 10253-4:2008 Butt-welding pipe fittings - Part 4: Wrought austenitic and austenitic-ferritic (duplex) stainless steels with specific inspection requirement
Bars	EN 10272:2007 Stainless steel bars for pressure purposes
Aluminium	EN 12392:2000 Aluminium and aluminium alloys - Wrought products - Special requirements for products intended for the production of pressure equipment (choose materials included in the list given in EN 13445-8 section 5.6)



Design stresses for some materials



- Design stresses for plates less than 12 mm thick applicable to membrane stress (safety factor 1.5 included) according to EN 13445-3
- · For stainless steels:

$$f = \frac{R_{p1.0}}{1.5}$$

$$f_{test} = \frac{R_{p1.0}}{1.05}$$

Material	R _{p1.0} (MPa)	f (MPa)	f _{test} (MPa)
1.4306 (304L)	240	160	228
1.4435/1.4404 (316L)	260	173	247
1.4406/1.4429 (316LN)	320	213	304
AW 5083-O/HIII		83	

• For aluminium-magnesium alloys: $f = \min(\frac{R_{p0.2}}{1.5}, \frac{R_m}{2.4})$ $f_{test} = \frac{R_{p0}}{1.0}$

Material	$R_{p1.0}/R_{m}$ (MPa)	f (MPa)	f _{test} (MPa)
AW 5083-O/HIII	125/270	83	119

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Best practices



- Using a coherent set of standards throughout the lifecycle of the cryostat is the simplest and safest approach. As an example when using only EN harmonised standards:
 - Error margins of pressure relief devices are taken into account in the design rules
 - The design rules are only applicable if the material has enough ductility
 - Materials certified for pressure vessels have measured minimum fracture toughness
 - Safety factors included in buckling formulae take into account shape imperfections up to the allowable tolerances layed out in the manufacturing section of the standards
 - The extent of welding inspection must be compatible with the joint coefficient used in thickness calculations
 - Coherence of test pressure and testing procedure with the design rules

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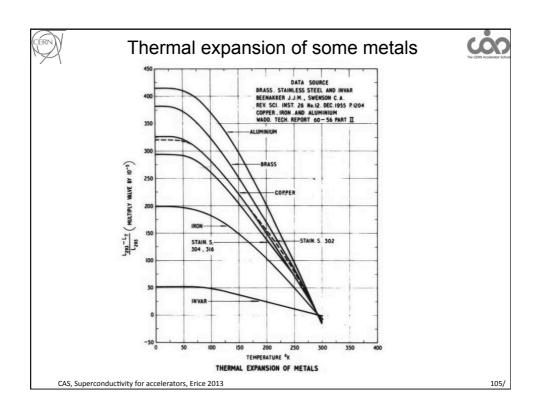
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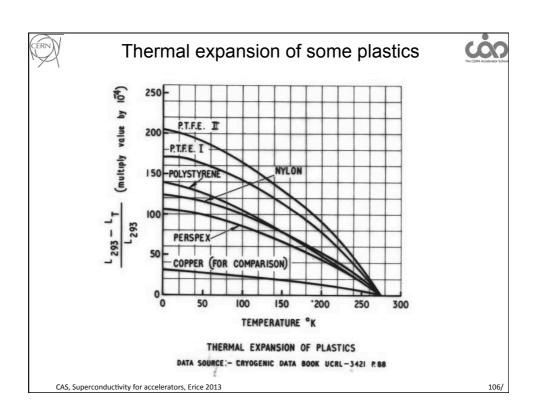


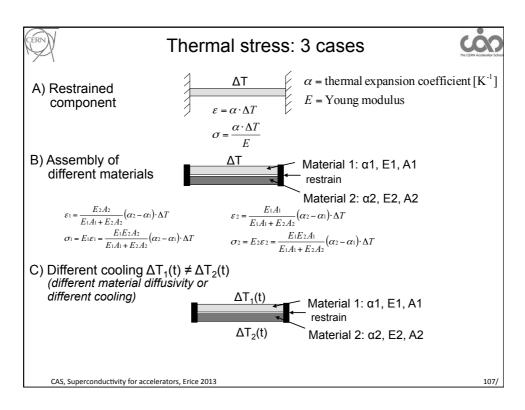


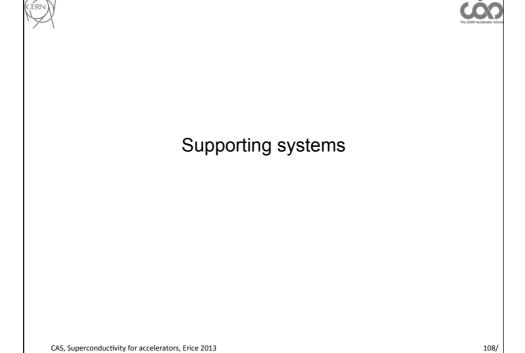
Thermo-mechanical considerations

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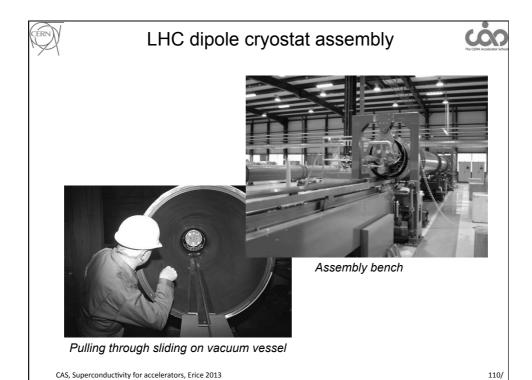
Supporting system



- Mechanical housing of cryogenic devices (supporting systems):
 - Supporting of (sometimes heavy) devices
 - Accurate & reproducible positioning (almost always)
 - Precise alignment capabilities (SC devices in accelerators)
- · Many solutions available:
 - Tie rods
 - Suspended posts
 - Compression posts
 - ...othe
- Each having specific advantages/drawbacks depending on:
 - Cold mass weight and cryostat assembly methods
 - Vacuum vessel external supporting (supported? Suspended?)
 - Adjustment of cold mass inside vacuum vessel
 - ..
- For the LHC, the compression posts were preferred because of :
 - Heavy cold masses (~30 tons!) → supported on jacks on tunnel floor
 - Cryostat assembly based on sliding (or rolling through) of cold mass standing on supports
 - No need for adjustment, magnets individually fiducialised and machine aligned w.r.t. external cryostat-mounted fiducials

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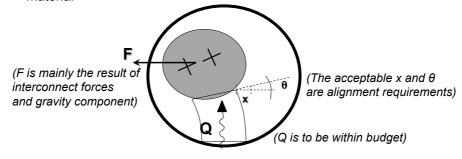


LHC Supporting system



The design is a trade-off between 2 conflicting requirements:

- High flexural stiffness (for mechanical stability) → thick and bulky structure
- Low heat in-leaks → thin and slender structure and low conductivity material



→ Flexural stiffness/conductivity is an interesting figure of merit in the choice of the material

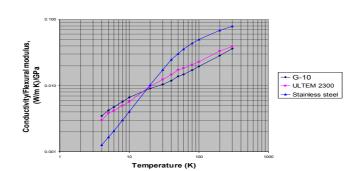
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Choice of the material (a few examples)





- St.steel → interesting below 20K
- G10 and Ultem 2300 → preferable at 20K < T < 300K
- Other interesting material: Carbon-fiber Epoxy → also interesting below 20 K (not shown in diagram)

For LHC, a Glass-fiber Epoxy Composite (GFRE) was chosen:

- · Good conductivity/flexural stiffness
- Widely available on the market → cost effective for large production (5000 units!)
- ...but a specific thermal conductivity validation campaign was needed.

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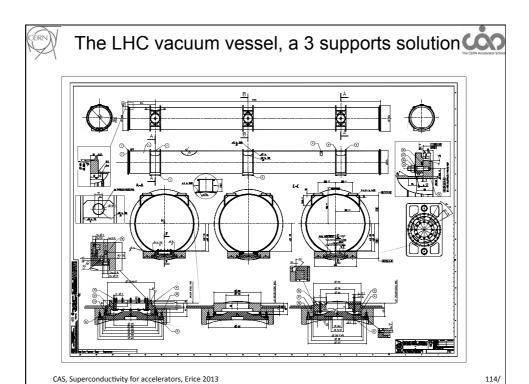
Supporting system



No. of supports, spacing and positions:

- 2 support posts whenever possible:
 - Isostatic: well known forces on cold mass/supports/vacuum vessel, not conditioned by handling
 - · Optimise spacing to minimize vertical sag
- Add 3rd support post if necessary for long cold masses:
 - · Limit vertical sag to acceptable values (cold mass straightness)
 - Hyper-static: precautions when handling, use of specific girders
- Position of support posts on vacuum vessel:
 - Always above the external jacks → direct load transfer from cold mass to ground, hence the vacuum vessel is unstressed (only vacuum loads).

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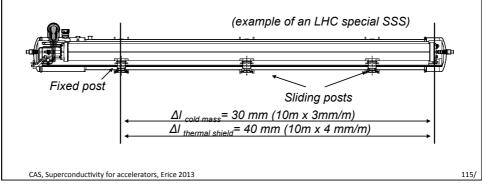


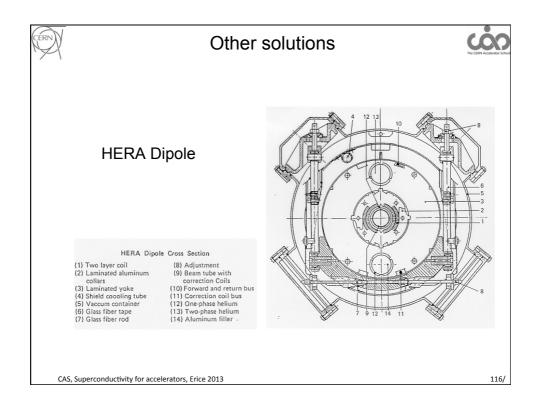


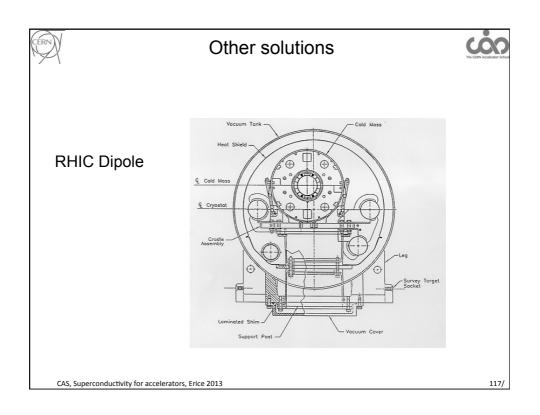
Longitudinal thermal contractions

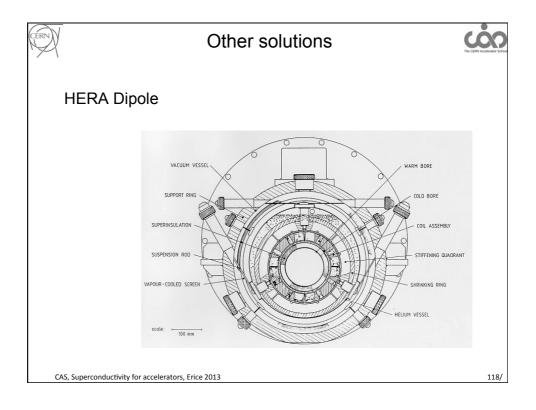


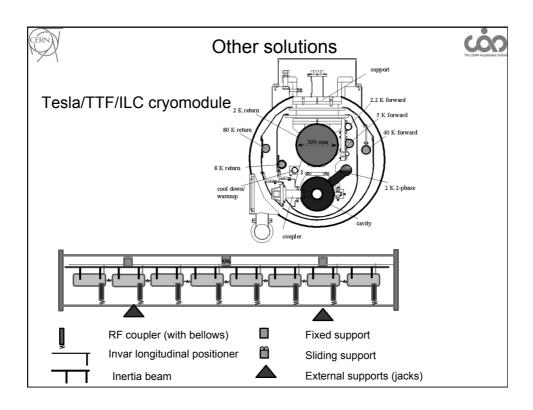
- Cold mass, thermal shield, support posts and vacuum vessel must be free with each other to cope with longitudinal thermal contractions
- · One fixed point per each component
- Leave plays to cope with all extreme T cases (ex. Cold mass cold, thermal shield warm)
- · Guided sliding of cold mass onto vacuum vessel
- · Flexible thermalisations anchors

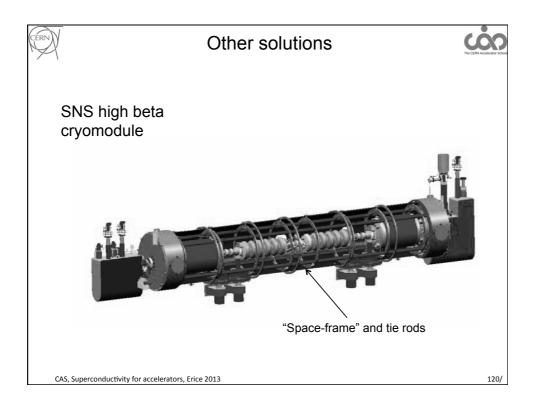


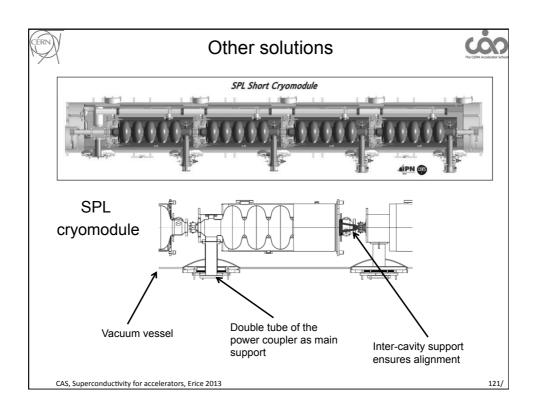


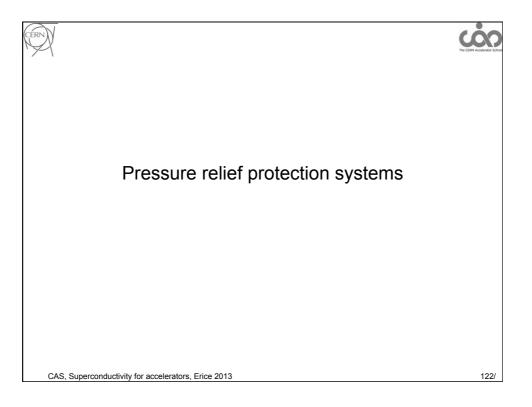














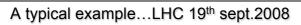
Pressure relief protection systems



- Cryostats include large cold surfaces, inventory of cryogenic fluids, sometimes large stored energy quantities (e.g. energized magnets)
 - a potentially unstable energy storage which will tend to find a more stable state of equilibrium
 - Through a thermodynamic transformation which can be sudden and uncontrolled with a dangerous increase of pressure
- Protect personnel (burns, ODH) and equipment (direct and collateral damage)
- · Risk hazards:
 - Sources of pressure:
 - · Compressors connected to cryo lines
 - · Connection to higher pressure source (e.g. HP bottles)
 - · Heating of "trapped" volumes (typically in a circuit between valves) during warm-ups
 - Helium leak to insulation vacuum, with consequent increased conduct/convection heat loads to cryogenic liquid vessels
 - Cryo-condensed air leaks on cold surfaces and consequent pressure increase and increased conduct/convection heat loads during warm-ups
 - Heating/vaporization of cryogens from sudden release of stored energy in SC device (e.g. quench or arcing in a SC magnet circuit)
 - Uncontrolled air/nitrogen venting of insulation vacuum with sudden condensation on cold surfaces
 - Uncontrolled release of cryogenic fluid to higher T surfaces (thermal shield and vacuum vessel), and consequent pressure increase and increased of conduct/convection heat loads to cold surfaces

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General approach



- · Make a thorough risk analysis and evaluate risk hazards
- Identify mitigation measures (e.g. protections of exposed bellows and flanged connections)
- · Identify severity of consequences and appreciate probability of the event
- Define the maximum credible incident(s) and design the safety relief system accordingly
- The safety relief system must be designed to keep pressure rise within the limits of the Maximum Allowable Working Pressure (MAWP)
- Estimate the heat exchange and its conversion to mass flow rates to be discharged
- Check the sizing of piping (generally designed for normal operation) to the relief device and increase if necessary
- Choose the type of safety device (burst disks, valves, plates) and size the safety device (DN and set pressure). Make use of safety device manufacturers formulas and charts
- Size recovery piping downstream of safety device and check venting needs in the buildings where the release occurs (ODH issue)

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Pressure Safety Relief Devices



- · Vacuum vessel
 - Typical PS (maximum allowable pressure) < 1.5 bara (<0.5 bar relative to atm.)
 - Safety device should keep

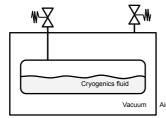
 $p_{max} < 1.5 bara$

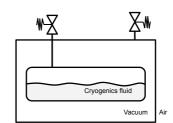
Define DN of valve and set pressure

- Cryogenic fluid vessel
 - Typical PS depends on the device (~few bara for SC cavities, up to ~ 20 bara for magnets)
 - Safety device should keep

 $p_{max} < PS$

Define DN of valve and set pressure





According to European directive 97/23/EC and EN 13648 "Safety devices for protection against excessive pressure"

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Cryogenic fluid vessel



The cryogenic fluid volume must be protected against over-pressure consecutive to unexpected heat transfers

Hazard: breach in insulation vacuum:

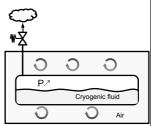
Uncontrolled air/nitrogen venting of insulation vacuum with sudden condensation on cold surfaces

Heat flux:

- From 3 experimental sources internationally recognised:
 - W. Lehman and G. Zahn, "Safety Aspects for LHe Cryostats and LHe Transport Containers," ICEC7, London, 1978
 - G. Cavallari, et. al., "Pressure Protection against Vacuum Failures on the Cryostats for LEP SC Cavities," 4th Workshop on RF Superconductivity, Tsukuba, Japan, 14-18 August, 1989
 - M. Wiseman, et. al., "Loss of Cavity Vacuum Experiment at CEBAF," *Advances in Cryogenic Engineering*, Vol. 39, 1994, pg. 997.

Experimental values:

- 0.6 W/cm2 for a superinsulated tank of a bath cryostat
- Up to 4 W/cm2 for a bare surface tank of a bath cryostat



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Cryogenic fluid vessel (cont.d)



- The safety device is designed to relieve a mass flow equivalent to the highest heat load
- Calculate the mass flow, Q_m to be released by the safety device (EN13468-3.4)

2 cases:

- Below critical pressure (p<2.23 bar for helium):
 - Bi-phase with liquid boil-off → take Lv (latent heat)
- Above critical pressure (often the case):
 - Supercritical fluid expelled → use a "pseudo latent heat" Lv'

$$L'=v\left[rac{\partial h}{\partial v}
ight]_{P0}$$
 where $rac{\sqrt{v}}{v\left[rac{\partial h}{\partial v}
ight]_{P0}}$ is maximum

P0	[bara]	P0 < 40% Pc	40% Pc <p0<pc< th=""><th>P0>Pc</th></p0<pc<>	P0>Pc
Qm	[kg/s]	$Q_m = \frac{W}{L}$	$Q_m = \left(\frac{v_g - v_l}{v_g}\right) \frac{W}{L}$	$Q_m = \frac{W}{L'}$

- P0 : relieving pressure [bara]
 Pc : critical pressure [bara] (2.23 for He)
 Qm : mass flow in [kg.s-¹]
- W : heat load [W]
- L : latent heat in relieving conditions [J.kg-1] (20.103 at 1 bar for He)
- vg/vl : specific volume of saturated gas/liquid at P0 [m³.kg⁻¹]
- L': specific heat input, see EN13468-3.4
- h : enthalpy of the fluid [J/kg] v : specific volume [m³.kg-¹]

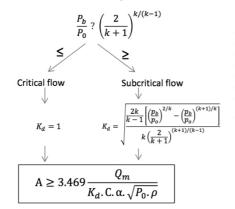
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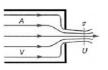
Cryogenic fluid vessel (cont.d)



- The minimum required flow area is calculated with conservative assumptions on fluid properties
- For compressible fluids, the mass flow through a restriction depends on the downstream pressure until a fixed Pb/P0 ratio (0.49 for helium)



- P0 : relieving pressure [bara]
- Pb: back pressure [bara] Qm: mass flow in [kg.h-1]
- A: required minimum cross-sectional flow area [mm2]
- k: isentropic exponent [-] (1.67 for He)
- ρ : density at upstream conditions [kg. m⁻³]
- α: discharge coefficient, depends on geometry.
- $C = 3.948 \sqrt{k \left(\frac{2}{k+1}\right)^{(k+1)/(k-1)}}$ (2.87 for He)



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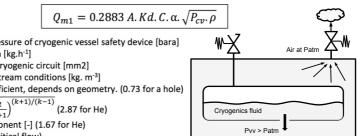


Vacuum vessel



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- The vacuum vessel safety device is designed to relieve a mass flow equal to the highest incoming flow at warmer temperature while keeping the vessel pressure within the PS
- Identify the worst case scenario (highest mass flow and coldest fluid)
- Often the worst case corresponds to a rupture of a cryogenic circuit:
 - ➤ The cryogenic fluid flows into the vacuum vessel → the fluid vaporizes/expands in contact with the warm walls → the internal pressure increases until the safety device set pressure → the device opens and the fluid is relieved to atmosphere
- Calculate the mass flow from the reservoir to the vacuum vessel
 - Estimate the area of the breach in the cryogenic circuit
 - Calculate the mass flow through an orifice



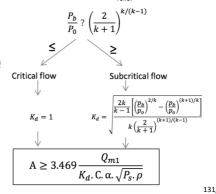
- Pcv: relieving pressure of cryogenic vessel safety device [bara]
- Qm: mass flow in [kg.h-1]
- A: orifice in the cryogenic circuit [mm2]
- ρ : density at upstream conditions [kg. $\mbox{m}^{\mbox{-}3}$
- $\alpha : \mbox{discharge coefficient, depends on geometry.} \ (0.73 \ \mbox{for a hole})$
- $C = 3.948 \sqrt{k \left(\frac{2}{k+1}\right)^{(k+1)/(k-1)}}$ (2.87 for He)
- k: isentropic exponent [-] (1.67 for He)
- Kd=1 (Pb<<P0 : critical flow)

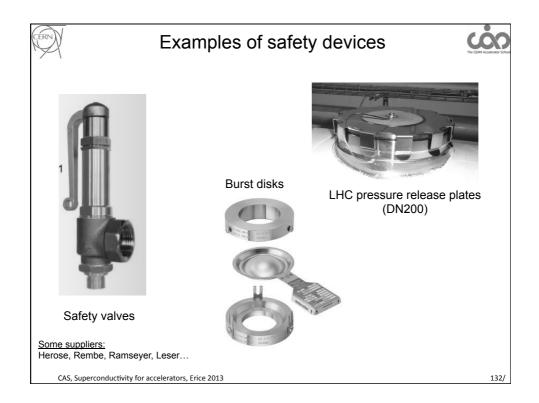


Vacuum vessel (cont.d)



- · Calculate the minimum required flow area, A for the safety device
 - Mass flow through the safety device = mass flow to the vacuum vessel
 - Qm1=Qm2
 - A > than the orifice area as Pb/P0 is lower and the gas is warmer.
 - The flow area is highly dependent on the relief temperature, usually difficult to estimate
 - First case T_{relief} = 300K
 - If the device is too big, investigations are needed to estimate T_{relief}
- Ps: relieving pressure [bara]
- Pb : back pressure [bara] (often atmospheric)
- Qm2 : mass flow in [kg.h⁻¹]
- A : required minimum cross-sectional flow area [mm2]
- k: isentropic exponent [-] (1.67 for He)
- ρ : density at upstream conditions [kg. m⁻³]
- α : discharge coefficient, depends on geometry.
- $C = 3.948 \sqrt{k \left(\frac{2}{k+1}\right)^{(k+1)/(k-1)}}$ (2.87 for He)







Summary



- Since Dewar's invention, cryostats have evolved from simple containers for cryogens to sophisticated mechanical assemblies for SC accelerator devices for fundamental science as well as for industrial applications (e.g. NMR machines)
- Though the understanding of the heat transfer phenomena involved in a cryostat have considerably progressed since the time of Dewar, the main outstanding innovation was the introduction of MLI, in the 50^{ties}...
- ...But the *enabling technologies*, have greatly evolved from "simple" "glass-blowing" to covering a wide range of disciplines, enhancing performance of modern cryostats:
 - Low thermal conductivity composite materials
 - Stainless steel (and low-carbon steel) sheet-metal work compatible with vacuum requirements
 - Vacuum and cryogenics technology
 - Leak-tight welding techniques
 - Leak detection with helium mass spectrometry
 - ..
- The cryostat design engineer is confronted with a multidisciplinary environment in which he needs to master "a little of everything"
- ...not to forget the industrialisation aspects when he is asked to produce cryostats in large series

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Thank you for your attention!

Questions?

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Acknowledgements



- The work presented in this course is essentially the result of contributions from a number of colleagues and the work done during the design and construction of the LHC
- I wish to acknowledge in particular for the material provided and for their contributions in preparing this course:
 - R.Bonomi, P.Cruikshank, Ph.Lebrun, Y.Leclercq, D.Ramos, A.Vande Crean and G.Vandoni

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